

<b>Title of Change:</b>	NCV2902DR2G: Additional Microdot on Top Mark
<b>Effective date:</b>	26 Jul 2023
<b>Contact information:</b>	Contact your local onsemi Sales Office or <a href="mailto:William.Bombita@onsemi.com">William.Bombita@onsemi.com</a>
<b>Type of notification:</b>	This Product Bulletin is for notification purposes only. onsemi will proceed with implementation of this change upon publication of this Product Bulletin.
<b>Change Category:</b>	Other
<b>Change Sub-Category(s):</b>	Shipping/Packaging/Marking

**Sites Affected:**

onsemi Sites	External Foundry/Subcon Sites
None	None

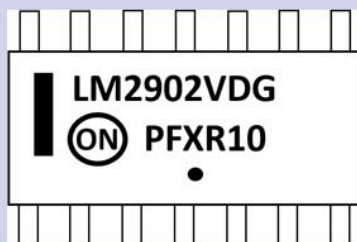
The NCV2902DR2G material, manufactured at the onsemi Carmona, Philippines location from WW06'23 to WW10'23, may have received an additional microdot in the marking. The presence of the microdot is applicable to the Lead (Pb) free designator for the SOIC8 and TSSOP package, while for the SOIC 14L NB, it is denoted by the suffix "G." Both designators were included in the materials produced between WW06'23 and WW10'23.

The affected units are good and tested 100% using production test program and no issue on electrical performance. This issue was resolved, and corrective action was applied to all material beginning WW11'23. "

**Details of the Marking Deviation:**

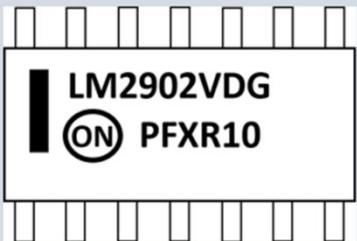
**Deviation in device marking: With additional Microdot**

Marking Deviation  
Material processed WW06-WW10'23



**Correct Marking and all other lots: Without Microdot**

Normal Marking  
All other materials



**List of Affected Standard Parts:**

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

NCV2902DR2G		
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